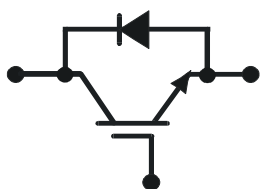


$V_{CE} = 1700\text{ V}$

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ABB HiPak™

# IGBT Module 5SNA 1800E170100



Doc. No. 5SYA 1554-03 Nov. 04

- Low-loss, rugged SPT chip-set
- Smooth switching SPT chip-set for good EMC
- Industry standard package
- High power density
- AlSiC base-plate for high power cycling capability
- AlN substrate for low thermal resistance



## Maximum rated values <sup>1)</sup>

Parameter	Symbol	Conditions	min	max	Unit
Collector-emitter voltage	$V_{CES}$	$V_{GE} = 0\text{ V}, T_{vj} \geq 25\text{ °C}$		1700	V
DC collector current	$I_C$	$T_c = 80\text{ °C}$		1800	A
Peak collector current	$I_{CM}$	$t_p = 1\text{ ms}, T_c = 80\text{ °C}$		3600	A
Gate-emitter voltage	$V_{GES}$		-20	20	V
Total power dissipation	$P_{tot}$	$T_c = 25\text{ °C}$ , per switch (IGBT)		11000	W
DC forward current	$I_F$			1800	A
Peak forward current	$I_{FRM}$			3600	A
Surge current	$I_{FSM}$	$V_R = 0\text{ V}, T_{vj} = 125\text{ °C}$ , $t_p = 10\text{ ms}$ , half-sinewave		16500	A
IGBT short circuit SOA	$t_{psc}$	$V_{CC} = 1200\text{ V}, V_{CEMCHIP} \leq 1700\text{ V}$ $V_{GE} \leq 15\text{ V}, T_{vj} \leq 125\text{ °C}$		10	$\mu\text{s}$
Isolation voltage	$V_{isol}$	1 min, $f = 50\text{ Hz}$		4000	V
Junction temperature	$T_{vj}$			150	°C
Junction operating temperature	$T_{vj(op)}$		-40	125	°C
Case temperature	$T_c$		-40	125	°C
Storage temperature	$T_{stg}$		-40	125	°C
Mounting torques <sup>2)</sup>	$M_1$	Base-heatsink, M6 screws	4	6	Nm
	$M_2$	Main terminals, M8 screws	8	10	
	$M_3$	Auxiliary terminals, M4 screws	2	3	

<sup>1)</sup> Maximum rated values indicate limits beyond which damage to the device may occur per IEC 60747

<sup>2)</sup> For detailed mounting instructions refer to ABB Document No. 5SYA2039

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### IGBT characteristic values <sup>3)</sup>

Parameter	Symbol	Conditions	min	typ	max	Unit	
Collector (-emitter) breakdown voltage	$V_{(BR)CES}$	$V_{GE} = 0 \text{ V}$ , $I_C = 10 \text{ mA}$ , $T_{vj} = 25 \text{ }^\circ\text{C}$	1700			V	
Collector-emitter <sup>4)</sup> saturation voltage	$V_{CE \text{ sat}}$	$I_C = 1800 \text{ A}$ , $V_{GE} = 15 \text{ V}$	$T_{vj} = 25 \text{ }^\circ\text{C}$	2.0	2.3	2.6	V
			$T_{vj} = 125 \text{ }^\circ\text{C}$	2.3	2.6	2.9	V
Collector cut-off current	$I_{CES}$	$V_{CE} = 1700 \text{ V}$ , $V_{GE} = 0 \text{ V}$	$T_{vj} = 25 \text{ }^\circ\text{C}$			12	mA
			$T_{vj} = 125 \text{ }^\circ\text{C}$		50	120	mA
Gate leakage current	$I_{GES}$	$V_{CE} = 0 \text{ V}$ , $V_{GE} = \pm 20 \text{ V}$ , $T_{vj} = 125 \text{ }^\circ\text{C}$	-500		500	nA	
Gate-emitter threshold voltage	$V_{GE(TO)}$	$I_C = 240 \text{ mA}$ , $V_{CE} = V_{GE}$ , $T_{vj} = 25 \text{ }^\circ\text{C}$	4.5		6.5	V	
Gate charge	$Q_{ge}$	$I_C = 1800 \text{ A}$ , $V_{CE} = 900 \text{ V}$ , $V_{GE} = -15 \text{ V} \dots 15 \text{ V}$		15.1		$\mu\text{C}$	
Input capacitance	$C_{ies}$	$V_{CE} = 25 \text{ V}$ , $V_{GE} = 0 \text{ V}$ , $f = 1 \text{ MHz}$ , $T_{vj} = 25 \text{ }^\circ\text{C}$		166		nF	
Output capacitance	$C_{oes}$			16.5			
Reverse transfer capacitance	$C_{res}$			6.98			
Turn-on delay time	$t_{d(on)}$	$V_{CC} = 900 \text{ V}$ , $I_C = 1800 \text{ A}$ , $R_G = 0.82 \text{ } \Omega$ ,	$T_{vj} = 25 \text{ }^\circ\text{C}$	290		ns	
			$T_{vj} = 125 \text{ }^\circ\text{C}$	300			
Rise time	$t_r$	$V_{GE} = \pm 15 \text{ V}$ , $L_\sigma = 60 \text{ nH}$ , inductive load	$T_{vj} = 25 \text{ }^\circ\text{C}$	230		ns	
			$T_{vj} = 125 \text{ }^\circ\text{C}$	250			
Turn-off delay time	$t_{d(off)}$	$V_{CC} = 900 \text{ V}$ , $I_C = 1800 \text{ A}$ , $R_G = 0.82 \text{ } \Omega$ ,	$T_{vj} = 25 \text{ }^\circ\text{C}$	920		ns	
			$T_{vj} = 125 \text{ }^\circ\text{C}$	1000			
Fall time	$t_f$	$V_{GE} = \pm 15 \text{ V}$ , $L_\sigma = 60 \text{ nH}$ , inductive load	$T_{vj} = 25 \text{ }^\circ\text{C}$	215		ns	
			$T_{vj} = 125 \text{ }^\circ\text{C}$	230			
Turn-on switching energy	$E_{on}$	$V_{CC} = 900 \text{ V}$ , $I_C = 1800 \text{ A}$ , $V_{GE} = \pm 15 \text{ V}$ , $R_G = 0.82 \text{ } \Omega$ , $L_\sigma = 60 \text{ nH}$ , inductive load	$T_{vj} = 25 \text{ }^\circ\text{C}$	380		mJ	
			$T_{vj} = 125 \text{ }^\circ\text{C}$	550			
Turn-off switching energy	$E_{off}$	$V_{CC} = 900 \text{ V}$ , $I_C = 1800 \text{ A}$ , $V_{GE} = \pm 15 \text{ V}$ , $R_G = 0.82 \text{ } \Omega$ , $L_\sigma = 60 \text{ nH}$ , inductive load	$T_{vj} = 25 \text{ }^\circ\text{C}$	560		mJ	
			$T_{vj} = 125 \text{ }^\circ\text{C}$	700			
Short circuit current	$I_{SC}$	$t_{psc} \leq 10 \text{ } \mu\text{s}$ , $V_{GE} = 15 \text{ V}$ , $T_{vj} = 125 \text{ }^\circ\text{C}$ , $V_{CC} = 1200 \text{ V}$ , $V_{CEM \text{ CHIP}} \leq 1700 \text{ V}$		8500		A	
Module stray inductance	$L_{\sigma \text{ CE}}$			10		nH	
Resistance, terminal-chip	$R_{CC'+EE'}$		$T_C = 25 \text{ }^\circ\text{C}$	0.06		m $\Omega$	
			$T_C = 125 \text{ }^\circ\text{C}$	0.085			

<sup>3)</sup> Characteristic values according to IEC 60747 – 9

<sup>4)</sup> Collector-emitter saturation voltage is given at chip level

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### Diode characteristic values <sup>5)</sup>

Parameter	Symbol	Conditions	min	typ	max	Unit	
Forward voltage <sup>6)</sup>	$V_F$	$I_F = 1800 \text{ A}$	$T_{vj} = 25 \text{ °C}$	1.4	1.65	2.0	V
			$T_{vj} = 125 \text{ °C}$	1.4	1.7	2.0	
Reverse recovery current	$I_{rr}$	$V_{CC} = 900 \text{ V},$ $I_F = 1800 \text{ A},$ $V_{GE} = \pm 15 \text{ V},$ $R_G = 0.82 \text{ } \Omega$ $L_{\sigma} = 60 \text{ nH}$ inductive load	$T_{vj} = 25 \text{ °C}$		1140		A
			$T_{vj} = 125 \text{ °C}$		1460		
Recovered charge	$Q_{rr}$	$V_{CC} = 900 \text{ V},$ $I_F = 1800 \text{ A},$ $V_{GE} = \pm 15 \text{ V},$ $R_G = 0.82 \text{ } \Omega$ $L_{\sigma} = 60 \text{ nH}$ inductive load	$T_{vj} = 25 \text{ °C}$		440		$\mu\text{C}$
			$T_{vj} = 125 \text{ °C}$		780		
Reverse recovery time	$t_{rr}$	$V_{CC} = 900 \text{ V},$ $I_F = 1800 \text{ A},$ $V_{GE} = \pm 15 \text{ V},$ $R_G = 0.82 \text{ } \Omega$ $L_{\sigma} = 60 \text{ nH}$ inductive load	$T_{vj} = 25 \text{ °C}$		590		ns
			$T_{vj} = 125 \text{ °C}$		890		
Reverse recovery energy	$E_{rec}$	$V_{CC} = 900 \text{ V},$ $I_F = 1800 \text{ A},$ $V_{GE} = \pm 15 \text{ V},$ $R_G = 0.82 \text{ } \Omega$ $L_{\sigma} = 60 \text{ nH}$ inductive load	$T_{vj} = 25 \text{ °C}$		310		mJ
			$T_{vj} = 125 \text{ °C}$		540		

<sup>5)</sup> Characteristic values according to IEC 60747 – 2

<sup>6)</sup> Forward voltage is given at chip level

### Thermal properties

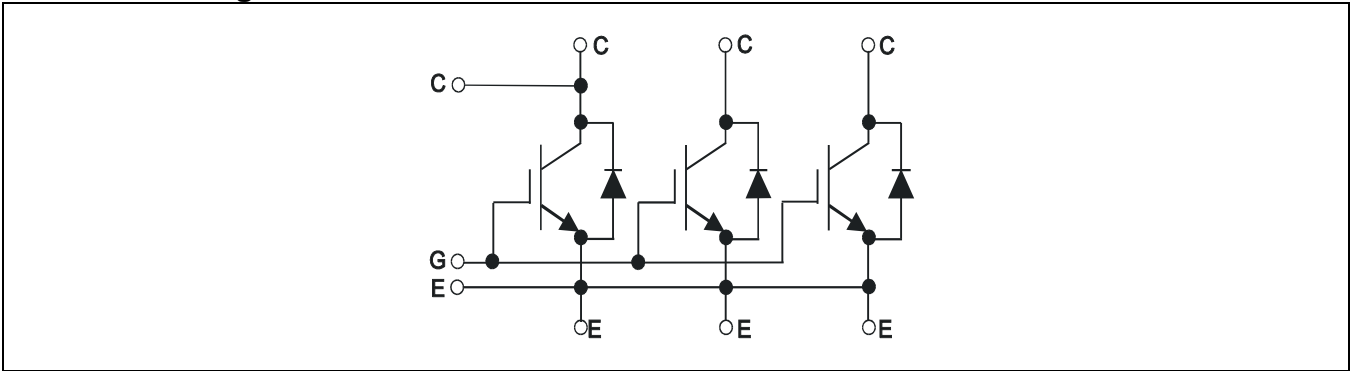
Parameter	Symbol	Conditions	min	typ	max	Unit
IGBT thermal resistance junction to case	$R_{th(j-c)IGBT}$				0.009	K/W
Diode thermal resistance junction to case	$R_{th(j-c)DIODE}$				0.017	K/W
Thermal resistance case <sup>2)</sup> to heatsink	$R_{th(c-h)}$	per module, $\lambda$ grease = $1\text{W/m} \times \text{K}$		0.006		K/W

<sup>2)</sup> For detailed mounting instructions refer to ABB Document No. 5SYA2039

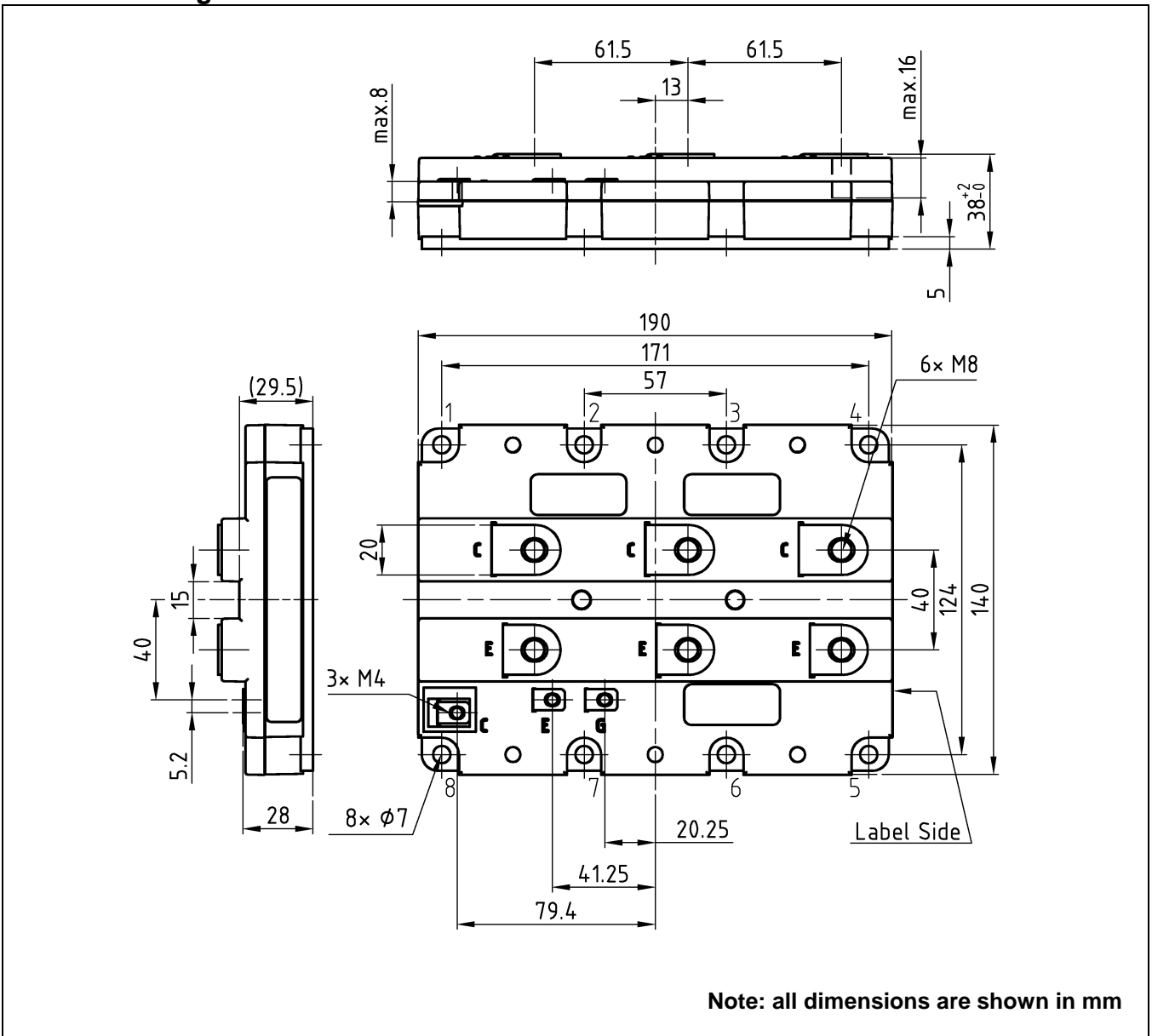
### Mechanical properties

Parameter	Symbol	Conditions	min	typ	max	Unit
Dimensions	$L \times W \times H$	Typical , see outline drawing	190 × 140 × 38			mm
Clearance distance	$D_C$	according to IEC 60664-1 and EN 50124-1	Term. to base:	23		mm
			Term. to term:	19		
Surface creepage distance	$D_{SC}$	according to IEC 60664-1 and EN 50124-1	Term. to base:	33		mm
			Term. to term:	32		
Weight				1380		g

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**Electrical configuration**



**Outline drawing** <sup>2)</sup>

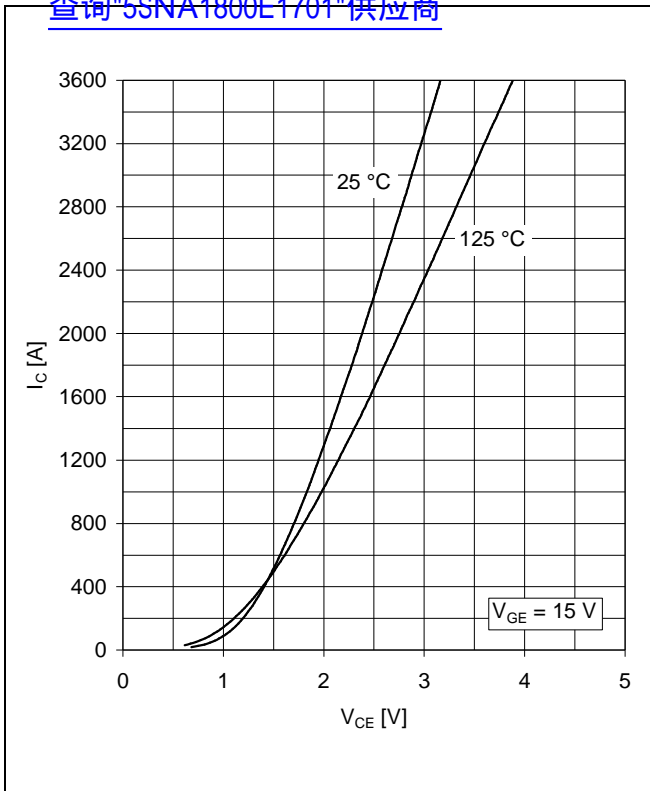


<sup>2)</sup> For detailed mounting instructions refer to ABB Document No. 5SYA2039

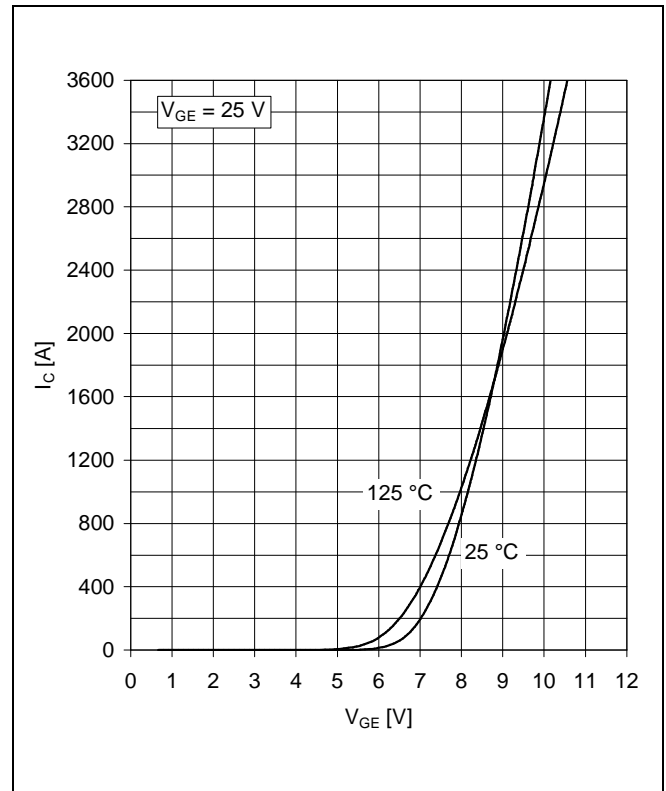
**This is an electrostatic sensitive device, please observe the international standard IEC 60747-1, chap. IX.**

**This product has been designed and qualified for Industrial Level.**

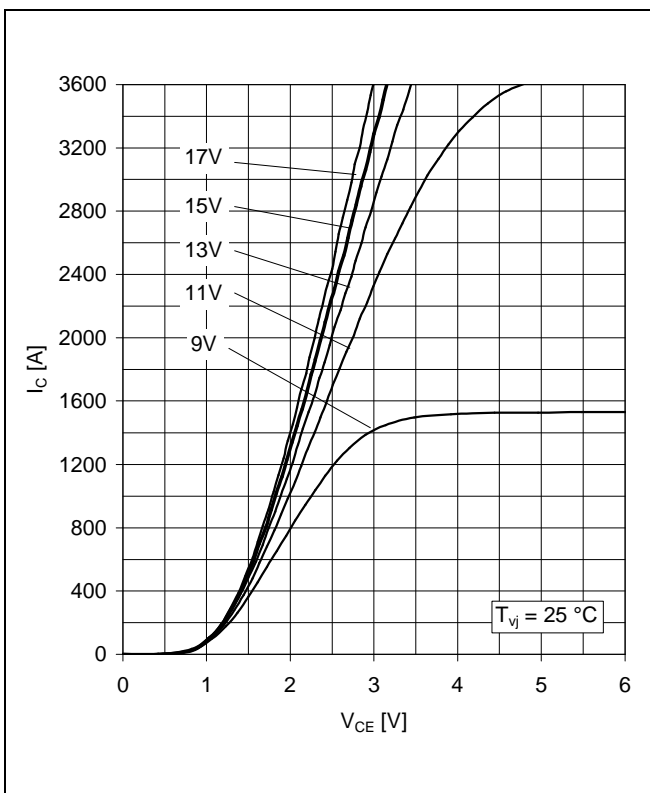
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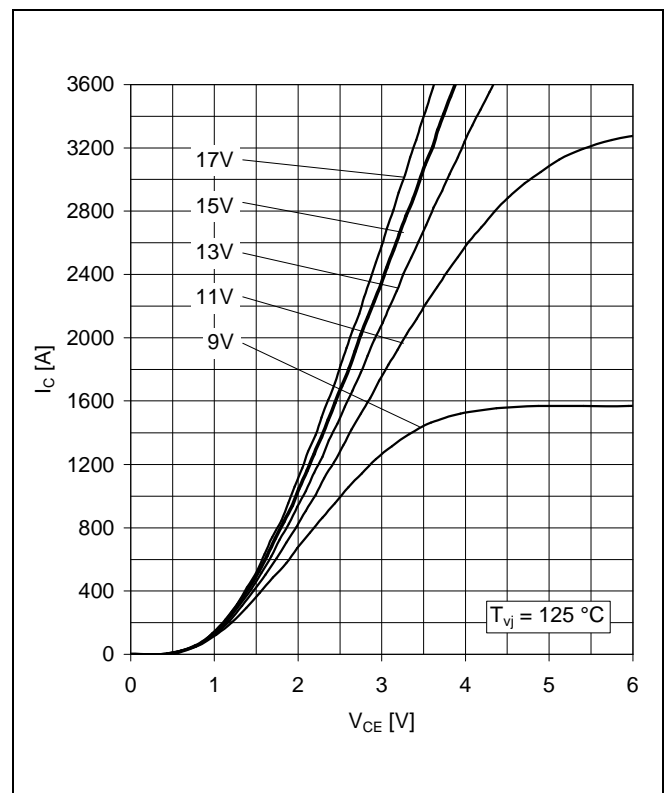
**Fig. 1** Typical on-state characteristics, chip level



**Fig. 2** Typical transfer characteristics, chip level

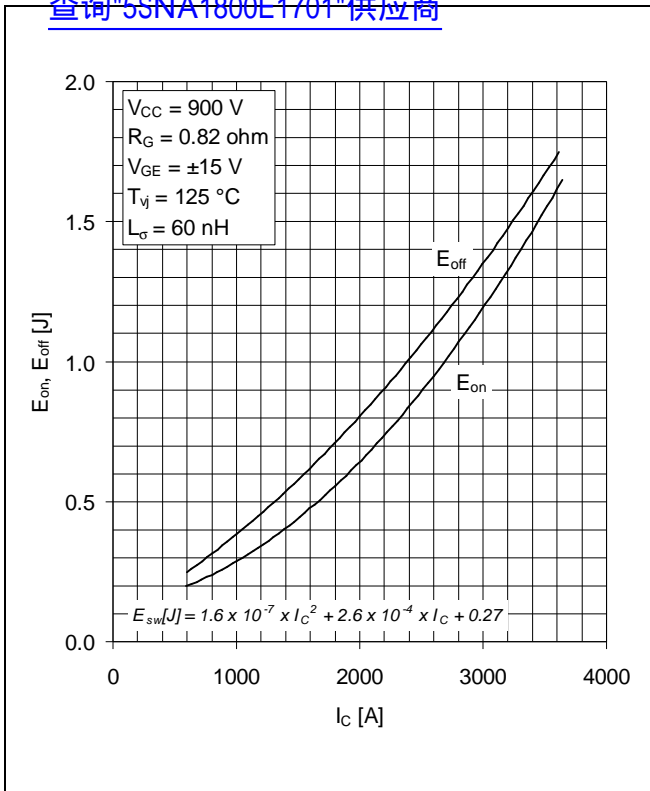


**Fig. 3** Typical output characteristics, chip level

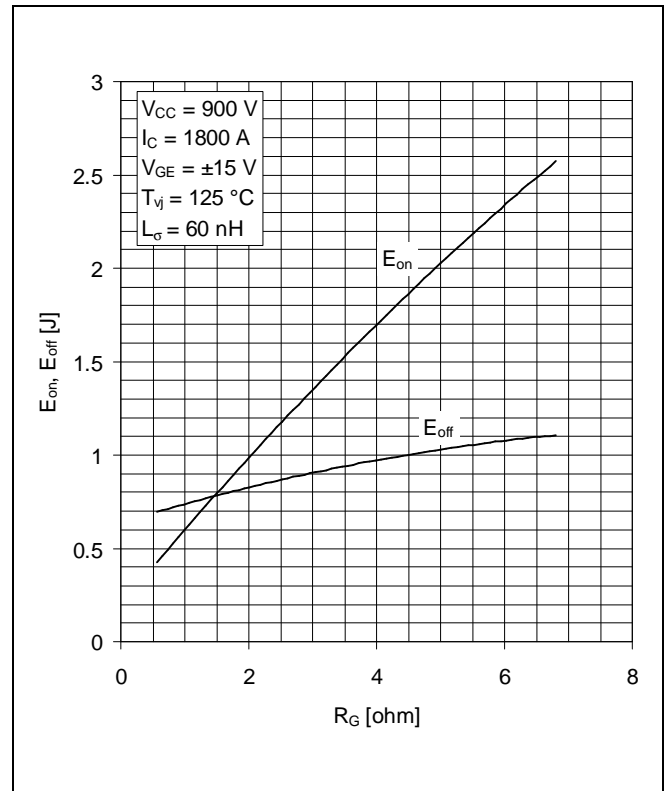


**Fig. 4** Typical output characteristics, chip level

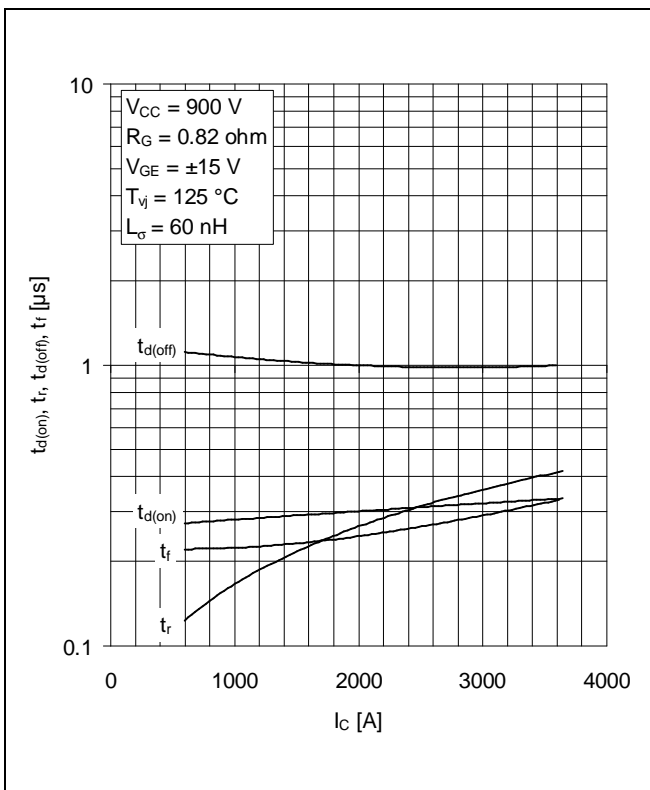
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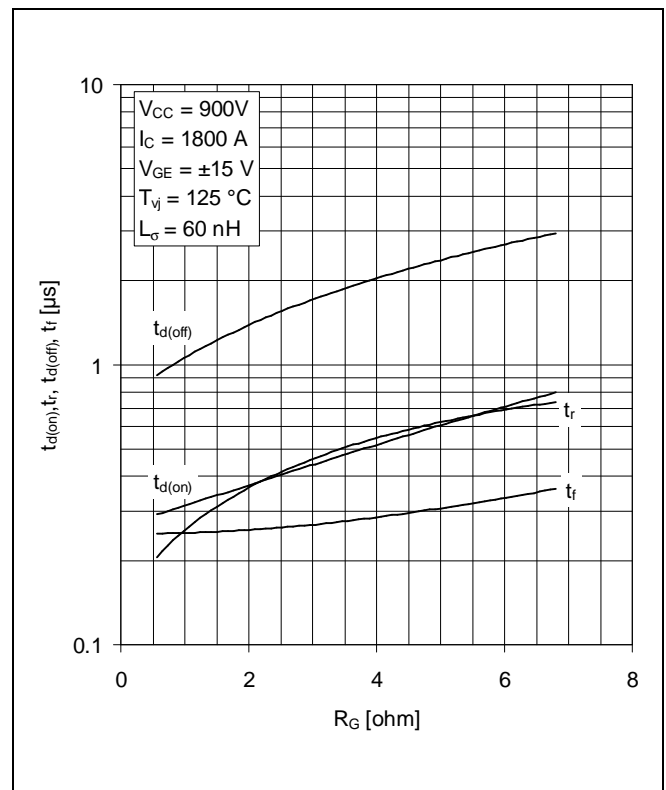
**Fig. 5** Typical switching energies per pulse vs collector current



**Fig. 6** Typical switching energies per pulse vs gate resistor

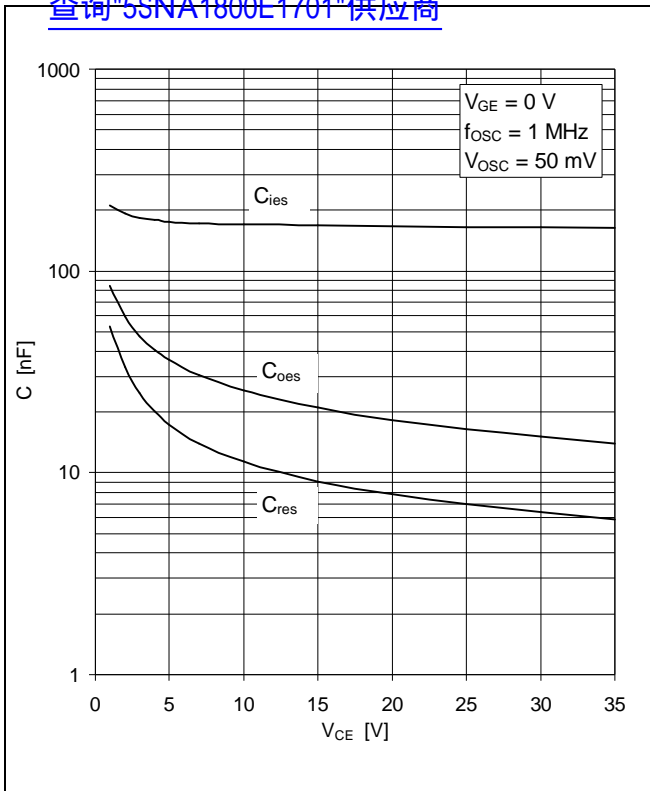


**Fig. 7** Typical switching times vs collector current

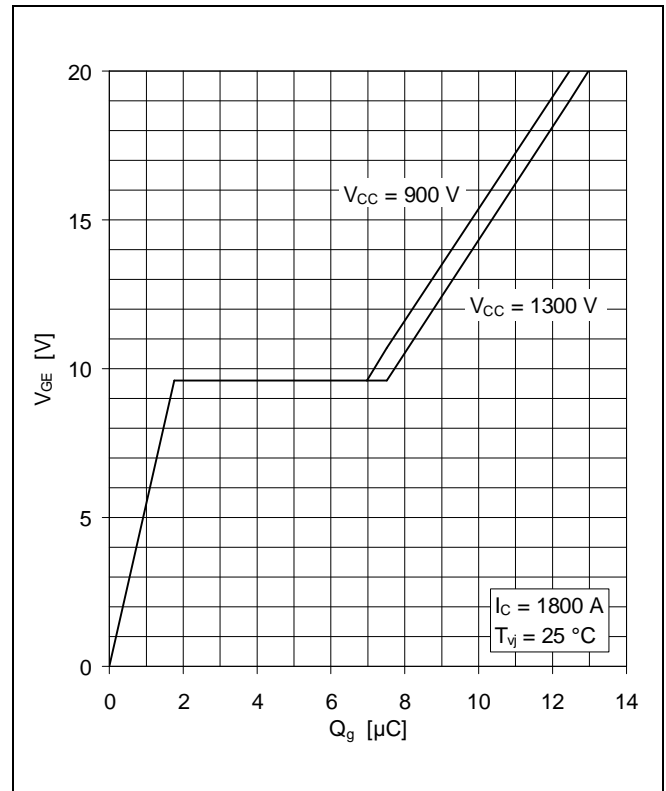


**Fig. 8** Typical switching times vs gate resistor

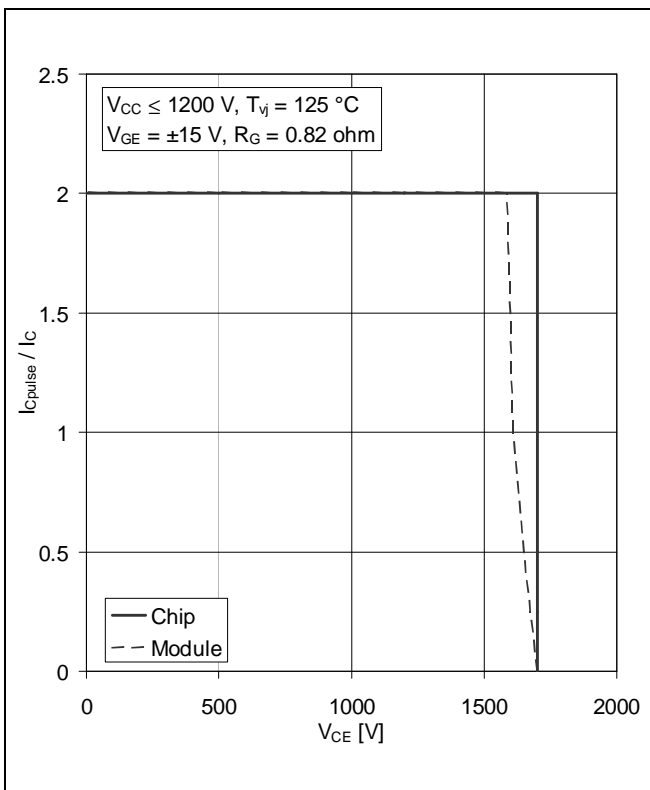
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**Fig. 9** Typical capacitances vs collector-emitter voltage

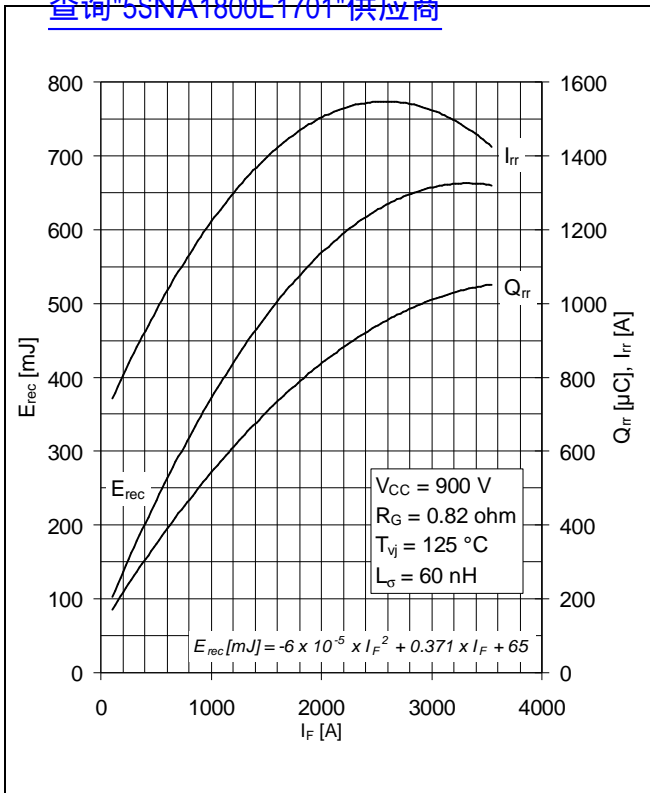


**Fig. 10** Typical gate charge characteristics

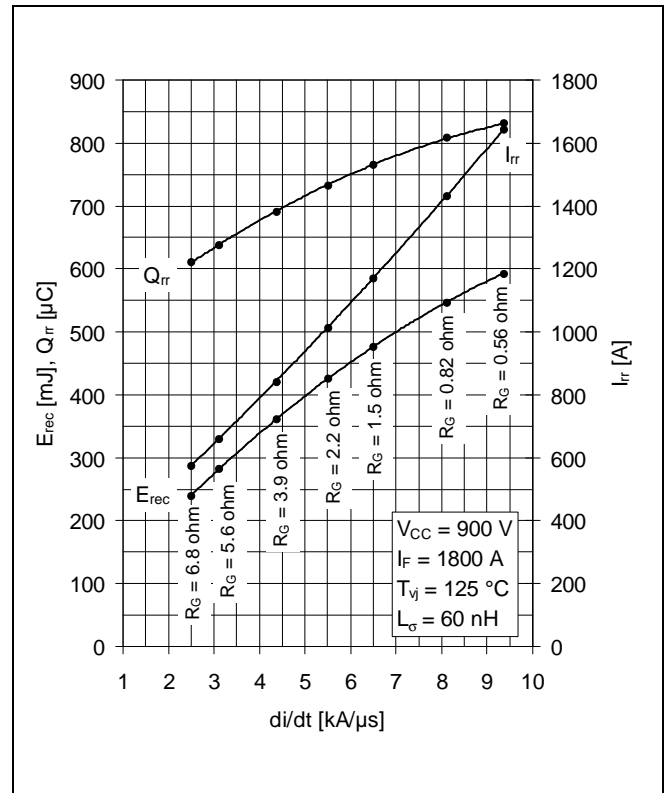


**Fig. 11** Turn-off safe operating area (RBSOA)

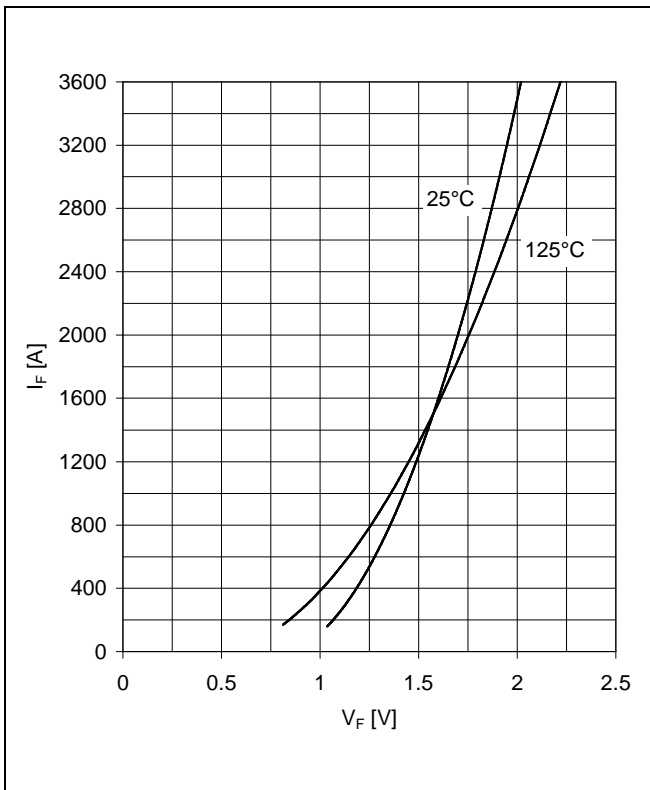
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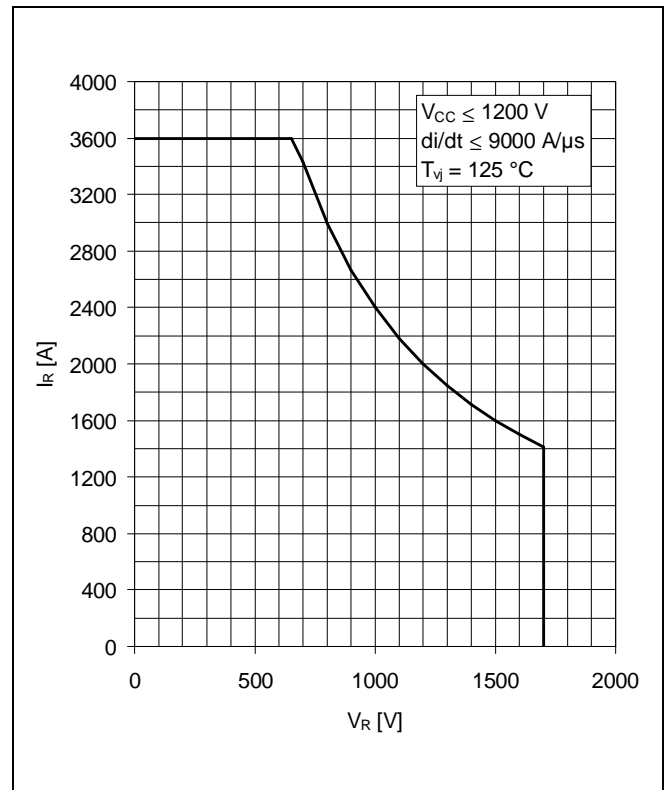
**Fig. 12** Typical reverse recovery characteristics vs forward current



**Fig. 13** Typical reverse recovery characteristics vs di/dt



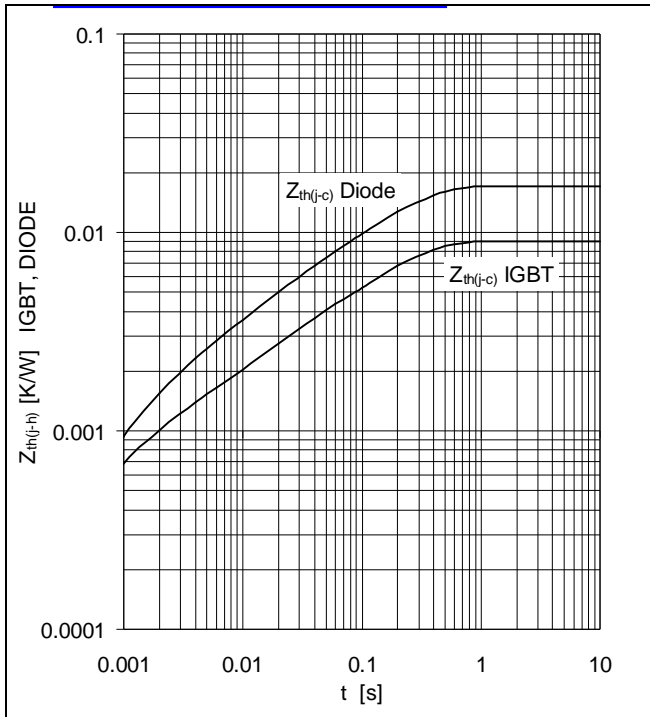
**Fig. 14** Typical diode forward characteristics, chip level



**Fig. 15** Safe operating area diode (SOA)



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**Fig. 16** Thermal impedance vs time

**Analytical function for transient thermal impedance:**

$$Z_{th(j-c)}(t) = \sum_{i=1}^n R_i (1 - e^{-t/\tau_i})$$

	i	1	2	3	4	5
IGBT	$R_i$ (K/kW)	6.24	1.73	0.704	0.345	
	$\tau_i$ (ms)	192	20.4	1.97	0.52	
DIODE	$R_i$ (K/kW)	11.6	2.91	1.28	1.27	
	$\tau_i$ (ms)	204	29.3	6.96	1.5	

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